

Applications

- Bluetoothtm wireless technology (Class 1)
- USB dongles
- PCMCIA, flash cards
- Access points
- 2.4 GHz cordless telephone

Features

- +22.5 dBm Output Power
- Low current 108 mA typical @ P_{OUT} = +20 dBm
- CMOS Enable Interface
- Power-control and power-down modes
- 3.3 V single supply operation
- Thin, lead-free 6 pin QFN package

Ordering Information

Part Number	Package	Remark
PA2423U	6 pin QFN (0.5 mm height)	Samples
PA2423U-R	6 pin QFN (0.5 mm height)	Tape & Reel
PA2423U-EV1	Evaluation Kit	. 100.

Product Description

A monolithic, high-efficiency, silicon-germanium power amplifier IC, the PA2423U is designed for 2.4 GHz wireless applications, including BluetoothTM Class1 and 2.4 GHz cordless telephone applications. It delivers +22.5 dBm output power making it capable of overcoming insertion losses of up to 2.5 dB between amplifier output and antenna input.

PA2423U

The PA2423U provides a digital control input for controlling power up and power down modes of operation.

The PA2423U operates at 3.3 V DC. At typical output power level (+22.5 dBm), the current consumption is 135 mA.

The silicon/silicon-germanium structure of the PA2423U, and its exposed die-pad package, soldered to the system PCB, provide high thermal conductivity and a subsequently low junction temperature. This device is capable of operating at a duty cycle of 100 percent. The device is pin for pin compatible to the PA2423L.

Functional Block Diagram

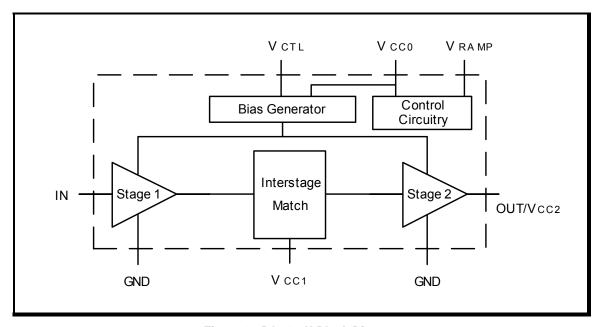


Figure 1: PA2423U Block Diagram



Pin-Out Diagram

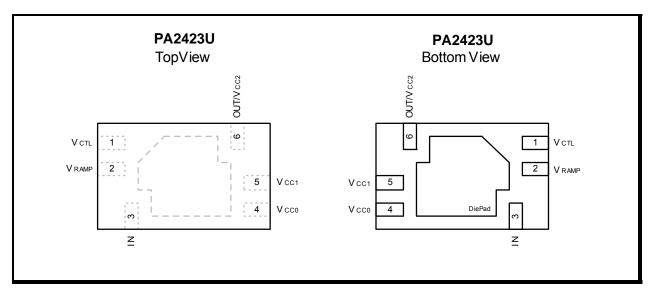


Figure 2: PA2423U Pin-Out

Pin Out Description

Pin No.	Name	Description
1	Vctl	Controls the output level of the power amplifier. An analog control signal between 0 V and Vcc varies the PA output power between minimum and maximum values
2	VRAMP	Power Amplifier Enable pin. A digital control signal with logic high (power up) and logic low (power down) is used to turn the device on and off.
3	IN	Power amplifier RF input, external input matching network with DC blocking is required
4	Vcc ₀	Bias supply voltage
5	Vcc1	Stage 1 collector supply voltage, external inter-stage matching network is required
6	OUT/Vcc2	PA Output and Stage2 collector supply voltage, external output matching network with DC blocking is required
Die Pad	GND	Heatslug Die Pad is ground



Absolute Maximum Ratings

Operation in excess of any one of above Absolute Maximum Ratings may result in permanent damage. This device is ESD sensitive. Handling and assembly of this device should be at ESD protected workstations.

Symbol	Parameter	Min.	Max.	Unit
Vcc	Supply Voltage	-0.3	+3.6	V
Vctl	Control Voltage	-0.3	V _{CC}	V
VRAMP	Ramping Voltage	-0.3	V _{CC}	V
IN	RF Input Power	-	+8	dBm
TA	Operating Temperature Range	-40	+85	°C
Тѕтс	Storage Temperature Range	-40	+150	°C
Tj	Maximum Junction Temperature	-	+150	°C

DC Electrical Characteristics

Conditions: $V_{CC0} = V_{CC1} = V_{CC2} = V_{RAMP} = V_{CTL} = 3.3 \text{ V}$, $P_{IN} = 0 \text{ dBm}$, $T_A = 25 \,^{\circ}\text{C}$, f = 2.45 GHz, input and output externally matched to 50Ω unless otherwise noted.

Symbol	Parameter	Min.	Тур.	Max.	Unit
Vcc	Supply Voltage	2.7	3.3	3.6	V
Icc	Supply Current (Icc = Ivcc0 + Ivcc1 + Ivcc2), VcTL = 3.3 V, Pout_MAX ≤ 22.5 dBm	-	135	160	mA
ΔІССТЕМР	Supply Current variation over temperature from T_A = 25 °C (-40 °C < T_A < +85 °C)	-	25	-	%
Vctl	PA Output Power Control Voltage Range	0	-	Vcc	V
I _{CTL}	Current sunk by VCTL pin	-	200	250	μΑ
VRAMP	Logic High Voltage	2.0	-	-	V
V RAMP	Logic Low Voltage	-	-	0.8	V
I _{stdby}	Leakage Current when VRAMP = 0 V, No RF, VCTL = high	-	0.5	10	μА



AC Electrical Characteristics

Conditions: $V_{CC0} = V_{CC1} = V_{CC2} = V_{RAMP} = V_{CTL} = 3.3 \text{ V}$, $P_{IN} = 0 \text{ dBm T}_A = 25 ^{\circ}\text{C}$, f = 2.45 GHz, input and output externally matched to 50Ω unless otherwise noted.

Symbol	Parameter	Min.	Тур.	Max.	Unit	
f _{L-U}	Frequency Range	2400	-	2500	MHz	
Pout_max	Output Power @ VcTL = 3.3 V	20.0	22.5	-	dBm	
Pout_min	Output Power @ VcTL = 0.4 V	-	-20	0	dBm	
ΔP_{temp}	Output Power variation over temperature (-40 °C < T _A <+85 °C)	-	1	2	dB	
dP _{OUT} /d V _{CTL}	Control Voltage Sensitivity	-	-	120	dBm/V	
Gss	Gain @ P _{IN} = -25 dBm	25.5	28.5	-	dB	
G _{VAR}	Gain Variation over band (2400-2500 MHz)	-	0.2	1.0	dB	
2f	Harmaniaa	-	-45	-30	dDo	
3f,	Harmonics	-	-40	-35	dBc	
IS ₂₁ Ioff	Isolation in "OFF" State, VRAMP = 0 V	15	36	-	dB	
IS ₁₂ I	Reverse Isolation	32	42	-	dB	
STAB	Stability (P _{IN} = 0 dBm, Load VSWR = 6:1)	All non-harmonically related outputs less than -50 dBc				



Typical Performance Characteristics

Test Conditions: SiGe PA2423U-EV1: $V_{CC0} = V_{CC1} = V_{CC2} = V_{RAMP} = V_{CTL} = 3.3 \text{ V}$, $P_{IN} = 0 \text{ dBm}$, $T_A = 25 \,^{\circ}\text{C}$, $f = 2.45 \,^{\circ}\text{C}$, input and output externally matched to 50Ω unless otherwise noted

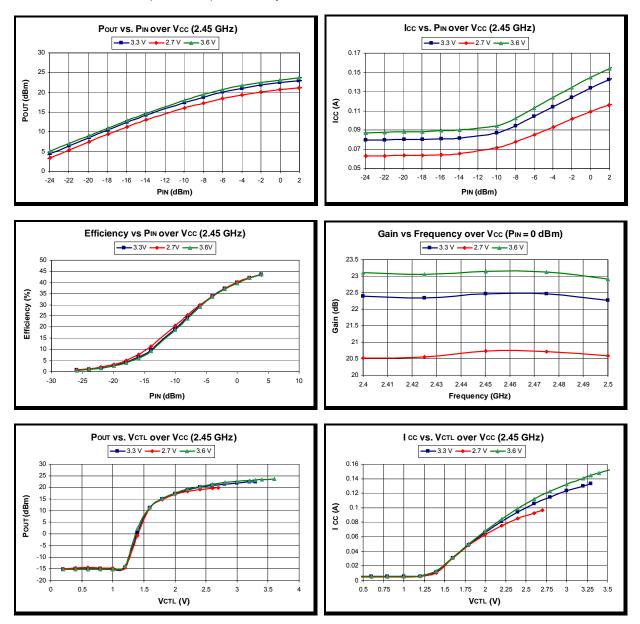
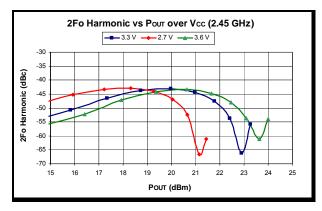


Figure 3: PA2423U Typical Performance Characteristics



Typical Performance Characteristics (Continued)



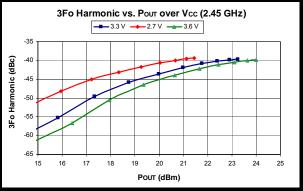


Figure 4: PA2423U Typical Performance Characteristics (Continued)

Application Circuit

Figure 5 is a representation of the PA2423U application circuit. For a detailed schematic and layout, refer to SiGe's PA2523U-EK1 Evaluation Kit Data Sheet (*Document Number: 131-DST-02*).

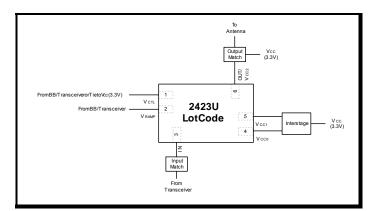


Figure 5: PA2423U Application Circuit

Branding Information

Figure 6 shows the branding for the PA2423U, including the Pin 1 location relative to the branding.

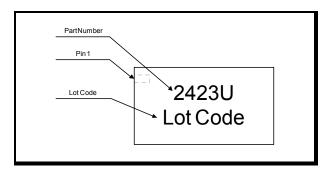


Figure 6: PA2423U Branding Information



Tape and Reel Information

Table 1 and Figure 7 show the PA2423U tape and reel information.

Parameter	Value
Reel Diameter	7 inches
Reel Width	8 mm
Units per Reel	3000

Table 1: PA2423U Tape and Reel Information

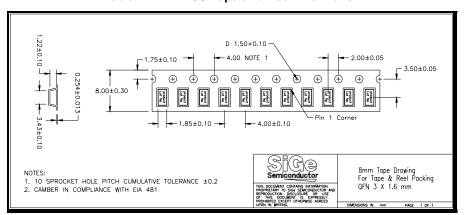


Figure 7: PA2423U Tape and Reel Diagram

Package Dimensions

The PA2423U is packaged in a 1.6 mm x 3.0 mm 6 pin QFN package, with a height of 0.5 mm. The detailed package drawing is shown in Figure 8. The underside of the package is an exposed die-pad structure. This allows for direct soldering to the PCB for enhanced thermal conductivity. The package dimensions are shown in the drawing below. The PA2423U is lead free.

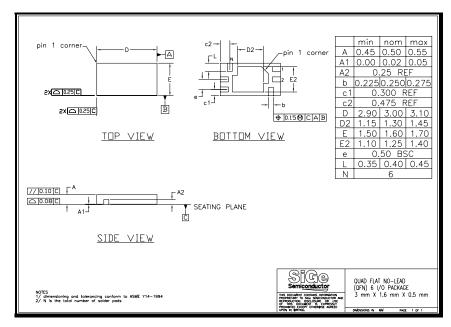


Figure 8: PA2423U Package Drawing



Recommended Application PCB Footprint Layout

Figure 9 shows SiGe's recommended PA2423U Application PCB footprint.

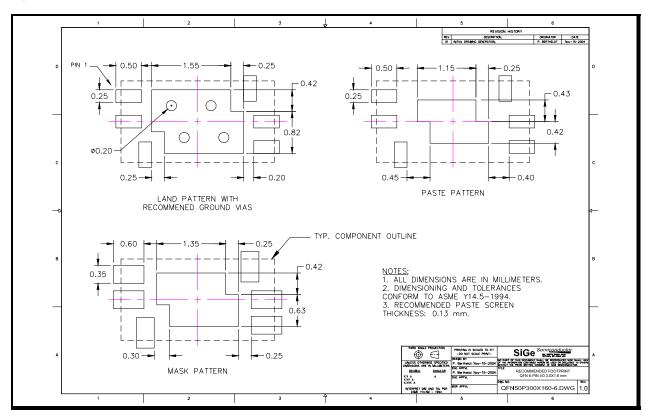


Figure 9: PA2423U Recommended Application PCB Footprint



PA2423U RangeCharger[™] 2.4 GHz Bluetoothtm Power Amplifier IC Preliminary

Applications Information

For test and design purposes, SiGe Semiconductor offers an evaluation board for the PA2423U. The order part number for the evaluation board is PA2423U-EV1. The evaluation board is intended to simplify the testing with respect to RF performance of this power amplifier.

The application note, 131-DST-02 provides the supporting information for using the evaluation board. It contains information on the schematic, bill of materials and recommended layout for the power amplifier and the input and output matching networks. To assist in the design process, this layout is available, upon request, in gerber file format.

Using VRAMP

 V_{RAMP} is a digital pin used to power-up and power-down the PA2423U in time division duplex systems such as Bluetooth 1.1. During receive mode, V_{RAMP} voltage is pulled down, PA2423U acts as a 35 dB isolation block between the radio and the antenna while consuming a modest 1 μ A. In transmit mode, V_{RAMP} voltage is pulled to V_{CC} and PA2423U offers 19 dB to 21 dB of large signal gain.

Using VCTL

VCTL is an analog pin that is designed to control the gain of PA2423U. Applying a voltage between 0 V and Vcc will adjust the gain between -15 dB and 21 dB. Used in combination with a variable drive level to PA2423U, the Vctl function can greatly optimize the PAE of the system at all four BluetoothTM transmitted power levels.

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Product Preview

The datasheet contains information from the product concept specification. SiGe Semiconductor, Inc. reserves the right to change information at any time without notification.

Preliminary Information

The datasheet contains information from the design target specification. SiGe Semiconductor, Inc. reserves the right to change information at any time without notification.

Production testing may not include testing of all parameters.

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